

Details of Proposal for the Conference

(ver.6 - 2018)

(Please keep handy all the relevant information pertaining to the proposed Conference while filling up the form against each of the 13 points mentioned to the best of knowledge and belief. Also go through the important aspects at the starting and notes appended to the form for information, guidance, and compliance. Form duly filled-up is to be submitted to IEEE Delhi Section <ieeedelhi@ieee.org> without deleting any part of it & signing at the end owning responsibility by the Conference Organizers for the information furnished and having noted all the aspects and points contained therein for necessary action towards holding the Conference once approved. Tampering of the Form at any place may lead to rejection of Proposal summarily.)

Some important aspects about which Conference Organizers must be aware of and hence read minutely before filling up the Details of Proposal for the Conference, are given below. Ignoring and / or avoiding these may delay processing of the Proposal so submitted.

1. Financial Sponsorship / Co-Sponsorship: One of the types of Sponsorship is Financial. An IEEE Organizational Unit (OU) or more OUs together and / or any other *not-for-profit* non-IEEE entity / entities can be Financial Sponsor or Co-Sponsors (in case of more than one entity) as per MOU (Memorandum Of Understanding) to be signed by them by providing seed money as start-up fund for the Conference in agreed proportion of a total of 100%. By doing so they agree to take the responsibility of sharing surplus / deficit arising out of holding the Conference in the same proportion.

Further as per the present policy of IEEE following are in vogue:

- The term "IEEE" shall be used in the names of sole Sponsored and Co-Sponsored Conferences where IEEE is at least 50% Financial Sponsor (in total for all IEEE Co-Sponsors).
- The use of the term "IEEE" in the names of Co-Sponsored Conferences in which IEEE is less than a 50% but at least a 25% Financial Sponsor (in total for all IEEE Co-Sponsors) is recommended but not required.

Thus implicitly the term "IEEE" in the names of Co-Sponsored Conferences in which IEEE is less than a 25% Financial Sponsor (in total for all IEEE Co-Sponsors) cannot be used. But for all other Conferences, as stated above, where IEEE has significant financial stake shall be IEEE owned Conference.

2. Technical Sponsorship / Co-Sponsorship: The other type of Sponsorship is Technical, i.e., involvement in the name, theme, track, paper-review process, technical program, publication, etc., i.e., overall technical quality of Conference. An IEEE Organizational Unit (OU) or more OUs together and / or any other *not-for-profit* non-IEEE entity / entities can be Technical Sponsor or Co-Sponsors (in case of more than one entity) as per MOU (Memorandum of Understanding) to be signed by them *along with Financial Sponsor / Co-Sponsors (in case of more than one entity)* without any Financial involvement (i.e., 0%). Collectively they shall be known as the "Sponsoring Parties". However, when any IEEE OU from MGA (Member & Geographic Area) side, like, Region, Geographic Council, Section, Subsection, Chapter, Affinity Group, Student Branch, Student Branch Chapter or TA (Technical Activities) side,

like, Technical Society, Technical Council is involved as Technical Sponsor or Co-Sponsors (in case of more than one entity) ONLY, following charges shall be levied.

- As per MGA, TCS Fee policy applicable with effect from January 1, 2018, US\$1,000 for the Conference and US\$15 per paper shall be charged to the Conference.

- In addition, Conference shall also have to pay Indian Rupee equivalent of US\$400 to IEEE Delhi Section.

- Upon completion of Conference, when accepted papers are to be submitted for inclusion into IEEE Xplore, with invoice raised by the IEEE MCE (Meetings, Conferences & Events) Team, TCS Fee due to MGA shall be paid by the Conference. At the same time Fee due to Section shall also be paid by the Conference.

3. Position of all other *not-for-profit & for-profit* bodies: Others who are not Sponsoring Parties but help in organizing the Conference may be termed as Contributor / Partner / Patron / Supporter.

4. Conference Budget has to include IEEE MGA TCS Fee as well as Section TCS Fee. Budget shall provide clear picture about income and expenditure in detail, preferably with 20% surplus (which is a must for IEEE owned Conference, as per IEEE norm).

5. Inclusion of IEEE Professional Members in organizing Conference is a must in key & major positions. Members involved in Technical Program Committee shall be eminent experts in the field from India as well as abroad. Similarly, shall be the constitution of Advisory Committee. For other Committees it is left to the discretion of Conference Organizers as per local necessity.

6. Time expected for scrutiny of Conference Proposal out of total lead-time for holding an IEEE level Conference, *new or serial one* (to avoid unnecessary interim query by the Conference Organizers):

- TWO months when lead-time is 12 to 18 months for a NEW Conference

- ONE month when lead-time is 9 to 12 months for a SERIAL Conference, being held for the second & subsequent times

7. Once rejected no more application shall be entertained for the same Conference by the same group or any other group at the same place or other place for ONE year.

8. To avoid conflict of interest *essentially* Members of Standing Committee on Technical & Professional Activities (Conferences) and Section Officers shall *NOT* be associated with the Conference in any capacity except for the following two cases:

- The Conference is being organized by the University / Institute / Organization with which Individual is affiliated / working

- For IEEE owned Conference (by Section and / or its Subsection / Chapter / Affinity Group / Student Branch / Student Branch Chapter) as stated above by compulsion involved in organizing the Conference

Even in such cases the individual(s) concerned shall refrain him/herself from evaluating the Conference Proposal, usually done by the Members of Standing Committee on Technical & Professional Activities (Conferences).

In the overall interest, however, it is *desirable* that even remaining Members of Section Executive Committee shall *NOT* be associated with the Conference in any capacity.

In the post-evaluation stage if the Conference is approved while normally Members of Standing Committee on Technical & Professional Activities (Conferences) shall constitute Section Oversight Committee, in order to facilitate holding the Conference, depending upon specialization other Members may as well be included in addition or by way of substitution. The organizers shall keep the Section Oversight Committee informed about Paper Submission and Review Process, Quality of accepted papers in terms of similarity level, reviews, etc. In case of Conferences owned by IEEE due to significant financial stake, quarterly income-expenditure statement shall be reported to IEEE entity/entities till the financial closure, in addition.

9. Restriction in use of IEEE branding and logos of its Societies, Technical Councils, Special Interest Groups, etc.: Without the permission of the concerned entities specifically neither the IEEE logo nor that of other entities shall be used. Section, Subsection, Chapter, Affinity Group, Student Branch, Student Branch Chapter are not authorized to give such permission on behalf of IEEE or its Technical Societies, Technical Councils, Special Interest Groups, etc. In this context appropriate time from which IEEE logo may be used has been mentioned under 5 of Important Notes appended.

10. Representative(s) of Financial Sponsor / Co-Sponsors, in case of Conferences not-owned by IEEE, cannot hold the major positions of General Chair / Chair, Technical Program Chair, Finance Chair / Treasurer, etc. for the Conference. Further, these positions shall be held by different persons.

Also, with one of the Organizers designated as the main contact person, there shall be *at least* one more contact person for and on behalf of the Conference.

11. GST and any other tax liability as imposed by any Government (state or central) shall be the responsibility of organizers to make provision in the budget for payment.

12. In case the Conference is with IEEE entity/entities as Financial Sponsor(s), the organizers shall maintain a separate account of Conference and submit audited report to the concerned IEEE Sponsoring entity/entities at the end of Conference, besides reporting quarterly income-expenditure statement.

(In case of any ambiguity and / or doubt opinion of IEEE MCE under the guidance of IEEE Conferences Committee shall be respected.)

Main Specifications:

- Name of the Conference (types, e.g., repeated in series periodically- 1st / 2nd, etc. and / or 2018 / 2019, etc., national / international with caution in usage having surety of fairly well participation from abroad):

1st International Conference on Signal Processing, VLSI and Communication Engineering (ICSPVCE-2019)

2. Date / Dates (single-day / multi-day): **28-30 March 2019**

3. Venue (Institute / Hotel / Convention Centre): **Delhi Technological University, Bawana Road, Delhi.**

4. Conference website: <http://www.dtu.ac.in/Web/ICSPVCE/index.html>

Other Details:

5. Organizing Entity / Entities (in case jointly), e.g., Educational Institute / University, not-for-profit public body, etc. vis-à-vis Organizers (Conference Chair, Technical Program Chair, Finance Chair / Treasurer, Publication Chair, Contacts, Committees - Advisory, Steering, Organizing, Technical Program, Finance, Publication, Publicity, Hospitality, Accommodation, Transportation, etc.) with details:

Delhi Technological University, Bawana Road, Delhi (sole Financial Sponsor).

Patron: Prof. Yogesh Singh, Vice Chancellor, DTU, Delhi.

General Chair: Prof. S. Indu, HOD(ECE), DTU, Delhi.

(Technical Program Chair IICIP-2016 held *during 12-14 Aug 2016* at DTU)

Organizing Co-Chairs: Prof Asok De, Professor, ECE, DTU

Prof. Rajeshwari Pandey, Professor (ECE), DTU, Delhi

(Publishing Co-Chairs IICIP-2016 held *during 12-14 Aug 2016* at DTU)

Technical Program Chair: Prof. Neeta Pandey, Professor (ECE), DTU, Delhi

(Finance Co-Chairs IICIP-2016 held *during 12-14 Aug 2016* at DTU)

Publishing Co Chair: Prof. Subrata Mukhopadhyay, Professor & Dean GTBIT, GGSIPU New Delhi Chair, Consultants Network Affinity Group, & ECC of IEEE Delhi Section

Prof. N S Raghava, Professor (ECE), DTU, Delhi

Finance Co Chairs: Prof. Rachana Garg, Professor (EEE), DTU, Delhi

Dr. Jeebananda Panda, Associate Professor (ECE), DTU, Delhi

International Advisory Committee:

1. Prof. Yahia Antar, Royal Military College, Canada
2. Prof. Kiyotoshi Yasumoto, Kyushu University, Japan
3. Prof. Sanjit K. Mitra, University of California, Santa Barbara, USA
4. Prof. Raj Mittra, Penn State University, PA, USA
5. Prof. Tatsuo Itoh, UCLA, Los Angeles, USA
6. Prof. Tapan Sarkar, Syracuse University, NY, USA
7. Prof. Anuj Srivastava, Florida State University, USA
8. Prof. Santanu Chaudhury, IIT Delhi, India
9. Prof. Chandra Shekhar, BITS Pilani, India
10. Prof. Bhabatosh Chanda, ISI Kolkata, India
11. Prof. G. Visweswaran, PES University, Bangalore, India
12. Prof. S. D. Joshi, IIT Delhi, India
13. Prof. M. T. Beg, JMI Delhi, India
14. Prof. S. Minaei, Professor, Dogus University, Turkey
15. Prof. Sushmita Mitra, ISI Kolkata, India
16. Prof. D. Biolek, University of Defence, Brno, Czech Republic
17. Prof. Madhusudan Singh, DTU, Delhi, India
18. Prof. Norbert Herencsar, Brno University of Technology, Czech Republic
19. Dr. Leila Safari, Tehran, Iran
20. Dr. Anurag Mangla, AMS AG, Austria
21. Dr. Jing-Ming Guo, National Taiwan University of Science and Technology, Taiwan
22. Prof. Dominik Slezak, University of Warsaw, Poland
23. Dr. Salvatore Vitabile, University of Palermo, Italy
24. Prof. Valentina Emilia Balas, Faculty of Engineering, Romania
25. Prof. Anca Ralescu, University of Cincinnati, USA
26. Prof. Zhihua Cui, Taiyuan University of Science and Technology, China
27. Dr. Reiner Dumke, NTU, Singapore
28. Dr. Rehan Sadiq, University of British Columbia Kelowna unit, Canada
29. Prof. Vijay Kumar, Missouri State University, USA
30. Dr. Deep Dumka, Qurvo, Inc, Dallas, USA
31. Dr. Meena Jha, Central Queensland University, Australia
32. Dr. Mumtaz, Ali, University of Southern Queensland, Australia
33. Prof. Irfan Deli, Kilis 7 Aralik Universitesi, Turkey
34. Dr. Said Broumi, Université Hassan II de Casablanca, Casablanca, Morocco
35. Prof. Ganeshsree Selvachandran, UCSI University, Kuala Lumpur, Malaysia
36. Prof. Antonino Staiano, University of Naples Parthenope, Italy
37. Prof. Fabio Caraffini, De Montfort University, Leicester, UK

38. Prof. Pham Van Hai, Hanoi University of Science and Technology, Vietnam
39. Prof. Hoang Viet Long, People Police of University of Technology and Logistics, Vietnam
40. Prof. Sung Wook Baik, Sejong University, Korea
41. Prof. Shuo-Yan Chou, National Taiwan University of Science and Technology, Taiwan
42. Prof. Ahmad Kamil Mahmood, University Teknologi Petronas, Malaysia
43. Dr. Kedar Rijal, Tribhuvan University, Nepal
44. Prof. Pankaj Jalote, IIT Delhi
45. Prof. Nupur Prakash, GGSIPU, India
46. Prof. Mini Thomas, NIT Trichy, India
47. Prof. Bhim Singh, IIT Delhi, India
48. Dr. Pradeep K. Atrey, State University of New York, USA
49. Prof. M. Hanmandlu, IIT Delhi, India
50. Prof. Prem K Kalra, IIT Delhi, India
51. Dr. Narendra S. Chaudhari, VNIT Nagpur, India
52. Dr. Manoj Singh Gaur, MNIT Jaipur, India
53. Dr. Mahesh Chandra Govil, MNIT Jaipur, India
54. Prof. Subhasis Chaudhuri, IIT Bombay, India
55. Prof. K. Rajagopal, IIT Mumbai, India
56. Prof. A. G. Ramakrishnan, IISC Bangalore, India
57. Dr. C. V. Jawahar, IIIT Hyderabad, India
58. Prof. P. J. Narayanan, IIIT Hyderabad, India
59. Prof. Shantaram Vasikarla, California State University, Northridge, CA, USA
60. Prof. Manoj Mishra, IIT Roorkee, India
61. Prof. K. K. Biswas, IIT Delhi, India
62. Dr. S. C. Bose, CEERI Pilani, India
63. Prof. Sudeb Dasgupta IIT Roorkee, India
64. Prof. Satyabrata Jit, IIT (BHU)-Varanasi, India
65. Prof. NVLN Murty IIT Bhubaneswar, India

Technical Program Committee

1. Prof. Sajal K Paul, ISM Dhanbad, India
2. Prof. Anshul Kumar, IIT Delhi, India
3. Prof. Santanu Chaudhary, IIT Delhi, India
4. Prof. Rajeev Tripathi, MNNIT, Allahabad, India
5. Prof. M. M. Gore, MNNIT Allahabad, India
6. Prof. M. Sawan, École Polytechnique, University of Montreal, Canada
7. Prof. M.T. Abuelma'atti, King Fahd University of Petroleum and Minerals Dhahran, Saudi Arabia
8. Prof. Worapong Tangsrirat, KMITL, Bangkok, Thailand
9. Prof. Fabian Khateb, Brno University of Technology, Brno, Czech Republic
10. Prof. Norbert Herenscar, Brno University of Technology, Czech Republic
11. Dr. Leila Safari, Tehran, Iran
12. Prof D. K. Lobiyal, JNU, India
13. Dr. Naveen Chauhan, NIT Hamirpur, India
14. Prof. M.S. Gaur, MNIT Jaipur, India
15. Dr. Narottam Chand, NIT Hamirpur, India

16. Dr. Eric Renault, Institute Telecom, France
17. Prof. A.K. Misra, MNNIT Allahabad, India
18. Prof. S. Dutta Roy, IIT Delhi, India
19. Prof. Mayank Dave, NIT Kurukshetra, India
20. Prof. S. K. Gupta, IIT Delhi, India
21. Prof. M. C. Govil, MNIT Jaipur, India
22. Prof. M. Kulkarni, NIT Surarkal, India
23. Dr. Anurag Mangla, AMS AG, Austria
24. Prof. Costas Psychalinos, Rio Patras, Greece
25. Dr. Arijit Raychowdhury, Georgia Institute of Technology, Atlanta, USA
26. Prof. George K. Karagiannidis, Aristotle University of Thessaloniki, Greece
27. Prof. Abdulhamit Subasi, Effat University, Saudi Arabia
28. Dr. Priyadarsi Nanda, University of Technology Sydney, Australia
29. Prof. D. R. Bhaskar, DTU, India
30. Prof. Rajiv Kapoor, DTU, India
31. Prof. O P Verma, DTU, India
32. Prof. P. C. Saxena, JNU, India
33. Prof. Dinesh Kumar, DTU, Delhi
34. Dr. Rajesh Rohilla, DTU, Delhi
35. Prof. Hassan El-Ghitani, Misr International University, Cairo, Egypt
36. Dr Victor Govindaswamy, Concordia University Chicago
37. Prof. Mu-Song Chen, Da-Yeh University, Taiwan
38. Prof. Sherali Zeadally, University of Kentucky, USA
39. Prof. Arvind Bansal, Kent State University, USA
40. Dr. Paul P. Sotiriadis, NTUA, Greece
41. Dr. Dinesh Kumar Saini, Sohar University, Sohar, Sultanate of Oman
42. Prof. Afaq Ahmad, Sultan Qaboos University, Muscat, Oman
43. Prof. Domenico Ciuonzo, Second University of Naples, Italy
44. Prof. Costas Kotropoulos, Aristotle University of Thessaloniki, Greece
45. Prof. Pascal Lorenz, University of Haute-Alsace, France
46. Dr. Montree Kumngern, King Mongkut's Institute of Technology, Thailand
47. Dr. G. Sen Gupta, Massey University, Palmerston North, New Zealand
48. Dr. Mahmoud Moghavvemis, University of Malaya, Malaysia
49. Dr. Jae-sun Seo, Arizona State University, Tempe, USA
50. Dr. Emre Arslan, Marmara University, Istanbul
51. Prof. Vinod Chandran, Queensland University of Technology, Brisbane, Australia
52. Prof. Alexandar Djordjevich, City University of Hong Kong, Hong Kong
53. Prof. Haranath Kar MNNIT, Allahabad, India
54. Prof. Ajay Somkuwar, MANIT Bhopal, India
55. Prof. G.K. Sharma, ABV-IIITM, Gwalior, India
56. Dr. Suman Kumar Saha, NIT Raipur, India
57. Dr. Pankaj Srivastava, ABV-IIITM, Gwalior, India
58. Prof. Shashikala Tapaswi, ABV-IIITM, Gwalior, India
59. Prof. O. P Sahu, NIT Kurukshetra, India
60. Prof. R. K. Sharma, AIACTR, Delhi, India
61. Prof. B. K. Kanaujia, JNU, Delhi, India
62. Prof. A. Q. Ansari, JMI, India
63. Prof. C. C. Tripathi, UIET, Kurukshetra, India
64. Prof. Rajoo Pandey, NIT Kurukshetra, India
65. Prof. Vikas Mittal, NIT Kurukshetra, India

66. Dr. R. K. Sharma, NIT, Kurukshetra, India
67. Ashish Kumar Ghunawat, MNIT, Jaipur, India
68. Dr. Amit Mahesh Joshi, MNIT, Jaipur, India
69. Dr. Ravi Kumar Maddila MNIT, Jaipur, India
70. Prof. R. P. Yadav, MNIT, Jaipur, India
71. Dr. Ritu Sharma, MNIT, Jaipur, India
72. Prof. K. K. Sharma, MNIT, Jaipur, India
73. Prof. Lava Bhargava, MNIT, Jaipur, India
74. Dr. Bharmjit Singh, NIT kurukshetra, India
75. Dr. M. M. Sharma, MNIT, Jaipur, India
76. Prof. Sajad A Loan, JMI, Delhi, India
77. Prof. Zaheeruddin, JMI, Delhi, India
78. Prof. Mainuddin JMI, Delhi, India
79. Prof. Zainul Abidin Jaffery, JMI, Delhi, India
80. Prof M Tariq Beg, JMI, Delhi, India
81. Prof. R. K. Nagaria. MNNIT Allahabad, India
82. Dr. Anwar Ahmad, JMI, Delhi, India
83. Prof. R. A. Mishra MNNIT Allahabad, India
84. Dr. Atin Mukherjee, NIT Rourkela, India
85. Prof. V.S. Tripathi MNNIT Allahabad, India
86. Prof. Shahida Khatoon JMI, Delhi, India
87. Dr. Dinesh Prasad, JMI, Delhi, India
88. Prof. R K Sarin, NIT Jalandhar, India
89. Dr. Aniruddha Chandra, NIT Durgapur, India
90. Prof. Barjinder Saini, NIT Jalandhar, India
91. Prof. Anurag Srivastava, ABV-IIITM, Gwalior, India
92. Prof. P. Deepa Shenoy, Bangalore University, India
93. Dr. V. Vaidehi, Anna University, India
94. Dr Ritu Garg, Accenture Operations AI Lab, Bangalore, India
95. Prof. Md Mansoorroomi, Tyagarajar College of Engineering, Madurai, Tamil Nadu, India
96. Dr. Rajeshwar Dass, DCRUST, Murthal, India
97. Dr. B. Satyabhama, Tyagarajar College of Engineering, Madurai, Tamil Nadu, India
98. Dr. Jaisingh Thangaraj, IIT(ISM) Dhanbad, India
99. Dr. B Yogameena, Tyagarajar College of Engineering, Madurai, Tamil Nadu, India
100. Prof Bindu Salim, PSG institute of Advanced studies, Coimbatore, India
101. Prof. Eric Castelli, MICA, Hanoi University of Science and Technology, Vietnam
102. Prof. Sreejaya P, Govt College of Engineering Trivandrum, India
103. Dr. Richa Mishra, NIT, Delhi, India
104. Dr. Rajat Kumar Singh, IIIT-Allahabad, India
105. Dr. Sachin Kumar Jain, IIITDM Jabalpur, India
106. Dr. Anil Kumar, IIITDM Jabalpur, India
107. Prof. Aditya Trivedi, ABV-IIITM Gwalior, India
108. Dr. Jasmin Kevric, International Burch University, Bosnia and Herzegovina
109. Dr. Surya Prakash Matcha, NIT Calicut, India
110. Dr. Sudeep P.V., NIT Calicut, India
111. Prof. Jiji C V, Govt College of Engineering Trivandrum, India
112. Prof. A. Biswas, Institute of Radio Physics and Electronics, University of Calcutta, India

- 113.Dr. Rachna Garg, DTU Delhi, India
- 114.Dr. Bhawna Aggarwal, NSIT, Delhi, India
- 115.Dr Anjan Kumar Ray, NIT Sikkim, India
- 116.Dr. Sanjay Kumar, NIT Sikkim, India
- 117.Dr. Jeevan A/I Kanesan, University of Malaya, Kuala Lumpur, Malaysia
- 118.Dr. W Wilfred Godfrey, ABV-IIITM Gwalior, India
- 119.Dr. Srikanta Pal, BIT Mesra, Ranchi, India
- 120.Dr. Kunwar Singh, NSIT, Delhi, India
- 121.Dr. Jyotsna Singh, NSIT, Delhi, India
- 122.Dr. Praveen Sankaran, NIT Calicut, India
- 123.Dr. Tarun kumar Rawat, NSIT, Delhi, India
- 124.Dr. Ankur Bansal, NSIT, Delhi, India
- 125.Dr. Shweta Gautam, NSIT, Delhi, India
- 126.Dr. Pragya Varshney, NSIT, Delhi, India
- 127.Dr. Sudipta Majumdar, DTU, Delhi, India
- 128.Dr. Priyanka Jain, DTU, Delhi, India
- 129.Dr. Malti Bansal, DTU, Delhi, India
- 130.Dr. N. Jayanthi, DTU, Delhi, India
- 131.Dr. D. K. Vishwakarma, DTU, Delhi, India
- 132.Dr. Anil Singh Parihar DTU, Delhi, India
- 133.Dr. Gurjit Kaur, DTU, Delhi, India
- 134.Dr. Poornima Mittal, DTU, Delhi, India
- 135.Dr. M. Rizwan, DTU, Delhi, India
- 136.Dr. K. Mini, DTU, Delhi, India
- 137.Dr. Santos Kumar Das, NIT Rourkela, India
- 138.Prof. Dheeraj Joshi, DTU, Delhi, India
- 139.Dr. Prasun Chongder, NIT Rourkela, India
- 140.Prof. Alka Singh, DTU, Delhi, India
- 141.Prof. Priya Mahajan, DTU, Delhi, India
- 142.Dr. Yusuke Nojima, Osaka Prefecture University, Japan
- 143.Dr. Vandana Nath GGSIPU, Delhi, India
- 144.Dr. Manoj Kumar GGSIPU Delhi, India
- 145.Dr. Danilo Pelusi, University of Teramo, Italy
- 146.Dr. Ravindra Kumar Purwar, GGSIPU Delhi, India
- 147.Prof. Kirti Gupta, BVCOE, Delhi, India
- 148.Prof. Jose Antonio Iglesias, Carlos III University of Madrid, Spain
- 149.Dr. Veepsa Bhatia, IGITUW, Delhi, India
- 150.Prof. Joaquin Miguez, The Charles III University of Madrid, Spain
- 151.Dr. Vandana Niranjana, IGITUW, Delhi, India
- 152.Dr. Rashmi Gupta, AIACTR, Delhi, India
- 153.Dr. M. Gangadharappa, AIACTR, Delhi, India
- 154.Dr. RK Singh, IET Lucknow, India
- 155.Dr. Rustem Popa, The Dunarea de Jos University of Galati, Romania
- 156.Dr. Aarti Jain, AIACTR, Delhi, India
- 157.Dr. Shweta Meena, NIT Kurukshetra, India
- 158.Prof. Ishwar Sethi, University of Oakland, Michigan, USA
- 159.Dr. Rajender Kumar, NIT Kurukshetra, India
- 160.Prof. Lisimachos Kondi, University of Ioannina, Greece

- 161.Dr. Poonam Jindal, NIT Kurukshetra, India
- 162.Mr. Dheeraj Kumar Sharma, NIT Kurukshetra, India
- 163.Mr. Sachin Gupta, Cypress Semiconductors Corporation, San Jose, California, USA
- 164.Mr. Rishik Bazaz, Intel Corporation, Chandler Arizona, USA
- 165.Mr. Sagar Malhotra, Synopsys Noida
- 166.Mr. Ankit Mittal, Greyorange India Pvt. Ltd., Gurgaon
- 167.Ms. Garima Bhatia, Arm Embedded Technologies Pvt Ltd., Gurgaon
- 168.Mr. Gaurav Verma, NIT Kurukshetra, India
- 169.Mr. Chagan Charan, NIT Kurukshetra, India
- 170.Mr. Gaurav Saini, NIT Kurukshetra, India
- 171.Mr. Sudakar Chauhan, NIT Kurukshetra, India
- 172.Dr. Anuraj Singh, Amity University, Noida, India
- 173.Dr. Prasenjit Chanak, ABV-IIITM, Gwalior, India
- 174.Dr. Gaurav Kaushal, ABV-IIITM, Gwalior, India
- 175.Dr. Prashant Shah, SVNIT, Surat, India
- 176.Dr. Shilpi Gupta, SVNIT, Surat, India
- 177.Dr. Kishor P. Upla, SVNIT, Surat, India
- 178.Dr. Tajinder Singh Arora, MSIT Delhi, India
- 179.Dr. Anu Mehra AMITY Noida, India
- 180.Dr. Archana Balyan, MSIT, Delhi, India
- 181.Dr. Paras, College of Technology, GBPUAT, Pantnagar, India
- 182.Dr. Nisha Gupta BIT Mesra, India
- 183.Dr. Vibha Vyas, College of Engineering Pune, India
- 184.Dr. Prabhat Kumar Sharma, VNIT Nagpur, India
- 185.Dr. D.Vaithyanathan, NIT Delhi, India
- 186.Dr. Jawar Singh, IIT Patna, India
- 187.Dr. Preetam Kumar, IIT Patna, India
- 188.Dr. Arvind Choubey, NIT Jamshedpur, India
- 189.Dr. Sudhir Kumar, IIT Patna, India
- 190.Dr. S. N. Singh, NIT Jamshedpur, India
- 191.Dr. Rajib Kumar Jha, IIT Patna, India
- 192.Dr. Manoj Sharma, BVCOE, Delhi, India
- 193.Dr. M. H. Kolekar, IIT Patna, India
- 194.Dr. P Rajalakshmi, IIT Hyderabad, India
- 195.Dr Vipul Singh, IIT Indore, India
- 196.Dr. Ashutosh nandi, NIT Kurukshetra, India
- 197.Dr. Kalpana Dhaka, IIT Guwahati, India
- 198.Dr. Prithwijit Guha, IIT Guwahati, India
- 199.Dr. Gaurav Trivedi, IIT Guwahati, India
- 200.Dr. Devendra Chack, IIT(ISM) Dhanbad, India
- 201.Dr. Kalyan Koley, IIT(ISM) Dhanbad, India
- 202.Dr. Vinay Kumar, NIT Meghalaya, India
- 203.Dr. Rajeev Kumar Ranjan, IIT(ISM) Dhanbad, India
- 204.Dr. Subindu Kumar, IIT(ISM) Dhanbad, India

205.Dr. Abhishek Sarkhel, NIT Meghalaya, India
206.Dr. Rahul Bhattacharya, IIT(ISM) Dhanbad, India
207.Dr. Vijay Nath, BIT Mesra, India
208.Dr. N. Chattoraj, BIT Mesra, India
209.Dr. Prasanna Misra, IIIT Allahabad, India
210.Dr. Surjeet, BVCOE, Delhi, India
211.Dr. Seema Awasthi, IIIT Allahabad, India
212.Dr. Suneel Yadav, IIIT Allahabad, India
213.Dr. Rikmantra Basu, NIT Delhi, India
214.Dr. Arpit Khandelwal, IIT Jodhpur, India
215.Dr. Aashish Mathur, IIT Jodhpur, India
216.Dr. Vinay Kumar, VNIT Nagpur, India
217.Dr. Ranjan Kumar Behera, IIT Patna, India
218.Dr. Vaishali Ingale, College of Engineering, Pune, India
219. Dr. Priti P. Rege, College of Engineering, Pune, India
220. Dr. Soumava Mukherjee, IIT Jodhpur, India
221.Dr. Ranjay Hazra, NIT Silchar, India
222.Dr. Ashwini Kumar Arya, College of Technology, GBPUAT, Pantnagar, India
223.Dr Sanjai Singh, IIIT Allahabad , India
224.Dr. Amit Garg, DCRUST Murthal, India
225.Dr. Santanu Behera, NIT Rourkela, India
226.Dr. Poonam Singal, DCRUST Murthal, India
227.Dr. Manoj Kumar Meshram IIT(BHU), Varanasi, India
228.Dr. Sanjay Mathur, College of Technology, GBPUAT, Pantnagar, India
229.Dr. Smrity Dwivedi, IIT(BHU), Varanasi, India
230.Dr. G Sreelekha , NIT Calicut, India
231.Prof Sarat K Patra, NIT Rourkela, India
232.Prof. R. P. S. Gangwar, College of Technology, GBPUAT, Pantnagar, India
233.Dr. Rajiv Tripathi, NIT Delhi, India
234.Dr. Shubhro Chakrabartty, NIT Goa, India
235.Dr. P Chinnamuthu, NIT Nagaland, India
236.Mr. Bijit Choudhuri, NIT Agartala, India
237.Prof. A. Choubey, NIT Jamshedpur, India
238.Dr. Amit Acharyya, IIT Hyderabad, India
239. Dr. Bal Chand Nagar, NIT Patna, India
240. Dr Chitralekha Ngangbam, NIT Manipur, India
241. Dr. Kunal Singh, NIT Jamshedpur, India
242. Dr. P Ranga Babu, NIT Meghalaya, India
243. Dr. Prabir Kumar Saha NIT Meghalaya, India
244. Prof. S N Singh, NIT Jamshedpur, India
245. Dr. G. Seetharaman, NIT Nagaland, India
246. Dr. Ashok Kumar, NIT Hamirpur, India
247. Dr. Basudeba Behera, NIT Jamshedpur, India
248. Dr. Shrishail Hiremath, NIT Rourkela, India

249. Dr Manish Goswami , IIIT Allahabad, India
250. Dr. M. K. Agarwal, GBPIET, Pauri Garhwal, India
251. Dr. Amritanshu Pandey IIT(BHU), Varanasi, India
252. Dr. B Acharya, NIT Raipur, India
253. Dr. Rudra Sankar Dhar, NIT Mizoram, India
254. Dr. Ch V Rama Rao, NIT Meghalaya, India
255. Dr. Mayank Srivastava, NIT Jamshedpur, India
256. Dr. Basanta Bhowmik, NIT Jamshedpur, India
257. Dr. T. Meenpal, NIT, Raipur, India
258. Dr. Gausia Qazi, NIT Srinagar, India
259. Dr. Deep Gupta, VNIT, Nagpur, India
260. Dr. Sougata Kumar Kar, NIT Rourkela, India
261. Dr. Shivnarayan Patida, NIT Goa, India
262. Dr. Z.M.Patel, SVNIT, Surat, India
263. Dr. Sayan Chatterjee, Jadavpur University, Kolkota, India
264. Dr. Sudhish N George, NIT Calicut, India
265. Dr. Rajib Kar, NIT Durgapur, India
266. Dr. Anindya Bose, The University of Burdwan, West Bengal, India
267. Dr. Kaushik Mazumdar, IIT(ISM) Dhanbad, India
268. Dr. Sanjay Dhar Roy, NIT Durgapur, India
269. Dr. K. M. Bhurchandi, VNIT, Nagpur, India
270. Dr. Basant Kumar, MNNIT Allahabad, India
271. Dr. Pradeep Kumar, NIT Sikkim, India
272. Dr. Pramod K Tiwari, IIT Patna, India
273. Dr. Vibha Rani Gupta, BIT Mesra, Ranchi, India
274. Dr. Harigovindan V P NIT Puducherry, India
275. Dr. Durbadal Mandal, NIT Durgapur, India
276. Dr. Raghvendra Kumar Chaudhary, IIT(ISM) Dhanbad, India
277. Prof. R. A. Patil, COEP, Pune, India
278. Dr. Gh. Rasool Begh, NIT Srinagar, India
279. Dr. Banibrata Mukherjee, NIT Rourkela, India
280. Dr. Jitendra K. Mishra, BIT Mesra, Ranchi, India
281. Dr. Jawad Y Siddiqui, University of Kalkatta, Kolkota, India
282. Dr. Soumya Pandit, Institute of Radio Physics and Electronics, University of Calcutta, India
283. Dr. R. C. S. Chauhan, IET Lucknow, India
284. Dr. Chandrima Mondal, Jadavpur University, Kolkota , India
285. Dr. Ravi Kumar, TIET, Patiala, India
286. Dr. Dibyendu Ghoshal, NIT Agartala, India.
287. Dr Ajay Singh Raghuvanshi, NIT Raipur, India
288. Dr. Pragati Patel, NIT Goa, India
289. Dr. Sanjay Kumar, TIET, Patiala, India
290. Prof. V. K. Singh, IET Lucknow, India
291. Dr. N. Parimala, JNU, India
292. Dr. Rajeev Srivastava, IIT Varanasi, India
293. Prof. Kavi Arya, IIT Bombay, India
294. Prof. Jitender Kumar Chhabra, NIT Kurukshetra, India
295. Dr. Devendra Kumar Tayal, IGDUTW Delhi
296. Prof. Debashis Ghosh, IIT Roorkee, India

297. Dr. Vinay Kumar, NIT Surathkal, India
298. Prof. Neeraj Tyagi, MNNIT Allahabad, India
299. Prof. M. N. Doja, JMI, India
300. Prof. Munna Khan JMI India
301. Prof. T. Islam JMI India
302. Prof. Ela Kumar, IGDTUW, India
303. Prof. Pragati Kumar, DTU, Delhi, India
304. Prof. Awadesh Kumar Singh, NIT Kurukshetra, India
305. Dr. S.K. Singh, IIT BHU, India
306. Dr. S. K. Soni, G. B. Pant Engg. College, Pauri, India
307. Dr. T. P. Sharma, NIT Hamirpur, India
308. Dr. G.C. Nandi, IIIT Allahabad, India
309. Prof. R.K. Agrawal, JNU, India
310. Prof. Brijesh Lal, IIT Delhi, India
311. Prof. Karmeshu, JNU, Delhi, India
312. Prof. S.R.N. Reddy, IGDTUW, Delhi, India
313. Dr. D.K. Yadav, MNNIT, Allahabad, India
314. Dr. Jasdeep Dhanoa, IGDTUW Delhi, India
315. Dr. Nidhi Goel, IGDTUW Delhi, India
316. Dr. Sudhakar Pandey, NIT, Raipur, India
317. Prof. Lalit Kumar Awasthi, NIT Hamirpur, India
318. Prof. O.P. Vyas, IIIT Allahabad, India
319. Prof. Devesh C. Jinwala, SVNIT Surat, India
320. Dr. Mukesh Zaveri, NIT Surat, India
321. Dr. Nitin Saxena, IIT, Kharagpur, India
322. Prof. Karamveer Arya, ABV- IIITM Gwalior, India
323. Prof. Deepak Bagai, PEC University of Technology, Chandigarh, India
324. Dr. Arti Noor, CDAC, Noida, India
325. Prof. M. P. S.Bhatia, NSIT, Delhi, India
326. Prof. Maneesha Gupta, NSIT, Delhi, India
327. Prof. Parul Garg, NSIT, Delhi, India
328. Prof. P. R. Chadha, DTU, Delhi, India
329. Prof. D. Upadhyay, NSIT, Delhi, India
330. Dr. S. K. Dhurander, NSIT, Delhi, India
331. Dr. J. Panda, DTU, Delhi, India
332. Prof. M.M. Tripathi, DTU, Delhi, India
333. Dr. Sampath Kumar, JSSATE, Noida, India
334. Dr. Kakali Chatterjee, NIT Patna, India
335. Dr. Rajiv Kumar, NSIT, Delhi, India
336. Dr. D. S. Kushwaha, MNNIT Allahabad, India
337. Dr. S. C. Agarwal IIT Kanpur, India
338. Dr. Kriti Bhushan NIT KU, India
339. Prof. M. M. Sufyan Beg, Jamia Milia Islamia, India
340. Dr. Vikram Goyal, IIIT Delhi, India
341. Dr. K K Bhardwaj, JNU, India
342. Dr. Amitabha Bagchi, IIT Delhi, India
343. Dr. Chander Bhasin Singh, MNNIT Allahabad, India
344. Prof. C S Rai, GGSIPU, India

345. Dr. Ash Mohammad Abbas, AMU, India
346. Dr. K. K. Shukla, IIT Varanasi, India
347. Dr. Rashid Ali, AMU, India
348. Dr. Shivani Goel, Thapar University, India
349. Dr. C. Mala, NIT Trichy, India
350. Dr. Naveen Kwatra, Thapar University, India
351. Prof. Sujata Pandey, Amity University, Noida, India
352. Prof. Rekha Gupta, ASET, Delhi, India
353. Prof. Alpana Agarwal, TIET, Patiala, India
354. Dr. Hemant Sharma, NIT Rourkela, India
355. Dr. D. Pati, NIT Nagaland
356. Prof. M. A. Joshi, College of Engineering, Pune, India

6. Research atmosphere prevailing at the Academic Institute / Research Institute / Industry at the helm of affairs for organizing the Conference, like, number of Ph. D. or higher Degree holders in the relevant areas, number pursuing, publications by the faculty / practicing engineer in referred journals / conference proceedings, such as IEEE Publications and other reputed ones (*naming the same*), research facilities provided / extended by the organization inside or outside, etc.:

- Number of Ph. D. or higher Degree holders in the relevant areas: **12**
(Electronics and Communication Engg Department, DTU)
- Number of publications of the Department: **145** (last 3 years)
- The department have full-fledged VLSI Lab, Communication Lab and Signal Processing Lab with all relevant tools.
- The department completed 3 sponsored projects, sponsored by Naval research Board and DST. Currently we have one ongoing project sponsored by DRDO. Apart from this, our faculties are regularly giving invited lectures in various educational institutes

7. Whether the proposed conference is being organized for the first time or it has been held earlier also, and in case of latter, please furnish brief about the same, like, new / old (with history concerning previous ones including names of organizers behind the conference):

Yes. The conference with this theme is being organized for first time. But last year we have organized IICIP 2016. Details of the people who have involved in organizing the conference are given below

Prof. S. Indu - Technical Program Chair IICIP-2016 held *during 12-14 Aug 2016* at DTU)

Technical Committee member of ICVGIP 12-16, NCVPRIPG 13-17, ICAPR 14-17

Prof. Rajeshwari Pandey -Publishing Co-Chairs IICIP-2016

Prof. Neeta Pandey - Finance Co Chairs IICIP-2016

Prof. Rachana Garg - Finance Co Chairs IICIP-2016, Also organized various IEEE

Conferences

Total Paper submitted : 550

Total accepted paper : 203

Total registered paper : 117

Total presented paper : 99

8. Theme and areas to be covered by the conference along with Tracks and probable Chairs and *if possible*, to which Society(ies) of IEEE the areas precisely belong, as areas may be under one or more Societies of IEEE:

The International Conference on Signal Processing, VLSI and Communication Engineering (ICSPVCE-2019) will be held at Delhi Technological University, Delhi. ICSPVCE aims to promote research and development in the in the areas of Signal Processing and Communication Engineering, as well as their implementation in VLSI. It will also bring together academia, industry, scientists, research scholars and students from the fields of Signal Processing, VLSI Design and Communication Technology to encourage sharing of knowledge and discussion.

ICSPVCE-2019 is focussed in creating a platform for dialogue on latest research in the fields of Signal Processing, VLSI and Communication, which have a considerable impact in the domain of Electronics and Communication Engineering. The submission of high quality, result oriented papers related to the topics is encouraged.

The proposed tracks include, but not limited to:

Track 01: Signal & Image Processing

- Image acquisition & Medical Image processing
- 3-D and Surface Reconstruction
- 3D and Stereo Imaging
- Application & Others
- Applications (Biomedical, Bioinformatics, Genomic, Seismic, Radar, Sonar, Remote Sensing, Positioning, etc.)
- Audio/Speech Processing and Coding
- Content-based Image retrieval
- Detection and Estimation of Signal Parameters
- Digital & Mobile Signal Processing

- Face Recognition
- Image acquisition & Medical Image processing
- Image coding and compression
- Image segmentation
- Motion Detection
- Nonlinear Signals and Systems
- Pattern Recognition and Analysis
- Signal Identification
- Signal Reconstruction
- Spectral Analysis
- Statistical & Optical Signal Processing
- Time-Frequency Signal Analysis
- Image-Based Modeling
- Image and Video Retrieval
- Internet Signal Processing
- Knowledge Representation and High-Level Vision
- Medical Image Analysis
- Multidimensional Signal Processing
- Multiple Filtering and Filter Banks
- Object Detection, Recognition and Categorization
- Pattern Recognition in New Modalities

Track 02: VLSI Design

- System-Level Design Methodologies
- Processor And Memory Design,
- On-Chip Communication Architectures

- Networks-On-Chip, Performance Analysis
- Logic And Physical Synthesis,
- Place And Route,
- Clock Tree Design,
- Physical Verification,
- Timing And Signal Integrity,
- Design Challenges For Advanced Technology Nodes
- Design Of Analog, Mixed-Signal, And RF IP
- Analog – Mixed Signal circuit
- Low-Power Analog And RF Circuit,
- Memory Design, Circuit
- Deep Nanoscale CMOS Devices,
- Device Modeling And Simulation,
- Design and Testing

Track 03: Communication

- Space-Time, MIMO and Adaptive Antennas
- OFDM, CDMA and Spread Spectrum
- Modulation, Coding and Diversity
- Signal Processing for Wireless Communications
- B3G/4G Systems, WiMAX, WLAN and WPAN
- Channel Model and Characterization
- Multi-Hop and Cooperative Communications
- Interference Cancellation and MUD
- Radio Resource Management and Allocation
- Cognitive Radio and Software Defined Radio
- Satellite & Space Communications

- Multimedia Communications
- Multiple Access Techniques
- Optical Communications

Track	Chair	Co- Chair
Signal & Image Processing	Prof. Santanu Choudhury IIT Delhi, India	Prof. S. Indu DTU Delhi, India
VLSI Design	Prof. Sajal K Paul IIT (ISM), Dhanbad, India	Prof. Neeta Pandey DTU Delhi, India
Communication	Prof. Asok De DTU Delhi, India	Prof. N. S. Raghava DTU Delhi, India

9. If there is provision for plenary session / state-of-the-art lecture(s), the name(s) of possible speaker(s) in order to judge the level of conference with distinguished lecturers (from IEEE Societies or experts otherwise):

The plenary sessions will be planned. Among the following speakers 2 or 3 speakers will be invited for plenary talk as per availability.

- Prof M Trivedi, Professor, UC San Deigo, Jacobs School of Engineering, USA
- Dr. Roy Chowdhury, University of California, Riverside, USA
- Prof Subhashish Chaudhury, IIT Bombay, India
- Prof Santanu Chaudhury, IIT Delhi, India
- Prof. Babuthosh Chanda, ISI Kolkata, India
- Prof Javahar, IIIT Hyderabad, India
- Prof P J Narayanan, IIIT Hyderabad, India
- Prof Sushmita Mitra, ISI Kolkata, India
- Dr. Noboru Matsuda, Carnegie Mellon University, USA
- Prof. S. K. Mitra, University of Southern California, Los Angeles, India
- Prof. P. N. Suganthan, Nanyang Technological University, Singapore
- Prof. Ranjan Bose, IIT Delhi
- Prof. Chandrashekhar, BITS Pilani, India
- Dr. Debashish Dutta, Ministry of IT, India
- Prof. S. D. Joshi, IIT Delhi, India

10. Time schedule with important dates – such as for, Abstract / Extended Abstract / Full Paper Submission, Acceptance Notification, Camera Ready Paper Submission, Registration, etc. (as placed with adequate interval of time) with sufficient time to be given for review by involving adequate number of qualified reviewers so that each paper is reviewed by at least 3 reviewers and no reviewer of the Conference papers gets more than 5 (ideally) or in the worst case maximum of 10 papers for review:

Deadline for full paper submission in IEEE Format	15th Sept 2018
Notification of paper acceptance	3rd Dec 2018
Camera ready paper submission	11th Feb. 2019
Author registration	15th Feb 2019
General registration	5th March 2019
Conference dates	28-30 march 2019

11. Whether the accepted papers, after due presentation (oral or poster) only, are intended to be published through the IEEE Xplore, besides local publication and *if yes*, then specific information about the review process and estimated number of papers to be submitted and possible acceptance (may be going by the previous few such conferences projection can be made for this time based upon quantitative assessment of numbers, though there may not be any hard and fast rule) in order to maintain quality of papers going to IEEE Xplore:

Yes. All accepted and presented papers will be sent for consideration for possible publication in IEEE Xplore.

The paper will be submitted through CMT. We will be using TURNITIN software for plagiarism check. The similarity score will be kept as per international norms (below 30%). The papers will be reviewed thoroughly. Each paper will be reviewed at least by 3 reviewers from the same area. We will opt for Double blind review for making the review process fair.

No. of expected papers: 500

No. of expected papers to be accepted:125

12. Details of how IEEE Organizing Unit (Section as Geographic Entity) to be associated in organizing the Conference in terms of human and other resources, which usually may be in the capacity of (Financial) Sponsor or one of the (Financial) Co-Sponsors, Technical Sponsor or one of the Technical Co-Sponsors and by the way of its Members in Committees:

IEEE Delhi Section as Technical Sponsor

13 Preliminary budget with estimated income and expenditure under various heads, like, Conference Registration Fee, Pre-Conference Tutorial Registration Fee, Fee from Exhibitors, Amount from (Financial) Sponsor or Co-Sponsors (usually refundable), Corporate and / or Institute Support (non-refundable), Publication Sale (maintaining appropriate copyright), Bank Interest, Other Income (*if any*), etc. as income on one hand and on the other hand expense on rental for space for Conference, Tutorial, Exhibition, audio, video, cost of food and beverages, transportation, publication & printing including through web, maintaining office, bank commission, IEEE MGA TCS Fee & Section TCS Fee, Other Expenses (*if any*), etc. with sufficient reserve margin planned (may be 20% or as suggested by the IEEE from time to time):

Estimated Expenditure:

Honorarium to speakers, session Chairs:	Rs. 1,00,000/-
TA/DA to speakers, session Chairs:	Rs.2,00,000/-
Conference Kit	: Rs. 1,50,000/-
Printing & Publication	: Rs. 1,00,000/-
Refreshments (lunch and Tea)	: Rs. 2,50,000/-
Accommodation to speakers	: Rs. 50,000/-
IEEE USA	: Rs 1, 65,000/- (USD 2500 (1000+1500))
IEEE Delhi section	: Rs 26,400/- (USD400)
Miscellaneous	: Rs. 2,00,000/-
Total	: Rs. 12,41,400/-

Estimated Income

From registration Fees	: Rs. 8,50,000/- 10,90,500 (115@Rs.7500/- +10@200USD+30@Rs. 3000/-)
From Sponsors	: Rs. 3,00,000/- (DTU)
Sponsorship from Industry	: Rs. 1,54,500/- (Ms. Eigen Technology, Online solutions, Agmatel)
Total	: Rs. 15,07,500/-

Our University will provide seed money of about Rs 2,50,000/- for starting the conference process and the same will be returned after completion of the same. Hence this amount is not included in the budget.

The payment to IEEE USA and IEEE Delhi section as per the new norms will be paid

Details of registration fees (per paper)

	Before 15 Feb 2019		After 15 Feb 2019*	
	Delegates (Academia, R&D)			
	International	Indian	International	Indian
IEEE Member	200 USD	Rs. 7500/-	300 USD	Rs. 8500/-
Non-IEEE member	230 USD	Rs. 9000/-	330 USD	Rs. 10000/-
	Student			
	International	Indian	International	Indian
IEEE Member	100 USD	Rs. 4000/-	150 USD	Rs. 4500/-
Non-IEEE member	115 USD	Rs. 5000/-	165 USD	Rs. 5500/-
	Industry			
	International	Indian	International	Indian
IEEE Member	400 USD	Rs. 12000/-	500 USD	Rs. 15000/-
Non-IEEE member	450 USD	Rs. 14000/-	550 USD	Rs. 16000/-
	Non-Author Participation			
IEEE Member	50 USD	Rs. 3000/-	70 USD	Rs. 4000/-
Non-IEEE member	75 USD	Rs. 3500/-	95 USD	Rs. 4500/-

* Last date of registration is 15 March 2019.

We are expecting 125 accepted papers. Out of which 10 papers may be international papers. Being in Delhi, we anticipate at least 30 attendees

Important Notes:

- After IEEE Delhi Section as a geographic Organizational Unit (OU) of IEEE gives its consent to be associated with the Conference in any capacity (Financial Sponsor / one of the Financial Co-Sponsors / Technical Sponsor/ one of the Technical Co-Sponsors), Conference Organizers are to apply online by submitting the Conference Application Form for getting registered with the IEEE (refer: http://www.ieee.org/conferences_events/conferences/organizers/conf_app.html) and get a 5-digit IEEE Conference Id number. Thereafter, a Memorandum of Understanding (MOU) shall be generated by the IEEE and sent to all the Financial Sponsor / Financial Co-Sponsors, and Technical Sponsor / Technical Co-Sponsors (collectively known as the "Sponsoring Parties") for approval.
- Upon approval, when MOU is executed, for abstracting & indexing with uploading in IEEE Xplore, *if it is intended*, Conference Organizers are to submit online Conference Publication Form (refer: http://www.ieee.org/conferences_events/conferences/organizers/conf_app.html?appName=Publication). Upon receiving the same, IEEE will send the Letter of Acquisition (LoA) which is an agreement between Conference and IEEE to consider Conference for acceptance into the Conference Publication Program (CPP) and IEEE Xplore®. The CPP handles the acquisition and exclusive

post-conference distribution of all conference publications for sponsored and co-sponsored conferences. Therefore, it is also necessary to pledge copyright of papers to IEEE. LoA provides the information how Conference Organizers need to submit the conference proceedings to IEEE. Conference Organizers must approve and sign the LoA for the content to be processed for posting to IEEE *Xplore*. It is important that they follow all the guidelines in the LoA, otherwise there may be a delay in posting the technical papers to IEEE *Xplore*. However, the LoA does not guarantee that the conference technical papers will be published in IEEE *Xplore*. IEEE can withhold the publishing of conference proceedings that do not meet the IEEE quality standards.

- Until and unless any IEEE Organizational Unit (OU) is substantially and directly involved with (Financial) Sponsoring, the name of IEEE shall not be included in the conference title.
- The word ‘International’ is also to be cautiously used until and unless there are good amount of participation from abroad and that too from a number of countries (*as expected by the IEEE*).
- Once MOU is signed by all (Financial) Sponsoring / Co-Sponsoring, and Technical Sponsoring / Co-Sponsoring parties, logo of IEEE may be used in the conference related documents.
- Conference web-site may start indicating *at appropriate time* (after applying for inclusion of papers presented in the Conference to IEEE Xplore) something like,

"..... (Conference Name) has applied for inclusion in the IEEE's Conference Publication Program. This means that the Conference proceedings of accepted papers (*for oral presentations*) will be submitted to IEEE Xplore."
- In whatever capacity IEEE Organizing Unit sponsors the Conference it shall be prudent for it to name a watchdog Oversight Committee consisting of experts from the relevant field(s) and those having experience of organizing Conference for playing a pro-active role as facilitator to the Conference.

Additional points to be considered:

1. Statutory clearances:

Statutory clearances that the organizers of International conferences, seminars, workshops, etc., have to obtain are as follows.

- Administrative approval of the Nodal Ministry: Union Ministry / Department under which theme / subject / area / topic falls is to be approached right at the first instance with conference name, theme / subject / area / topic, dates, venue(s), names of organizing / sponsoring / supporting entities, estimated number of national and international delegates (*naming*

countries), source of funding to meet expenditure, etc. specified. (In case conference is multi-area based, the Ministry / Department concerning the major area may be approached.)

- Event clearance from Ministry of Home Affairs: Section Officer (CC), Ministry of Home Affairs, Foreigners Division, NDCC Building II, Jai Singh Road, New Delhi - 110001 is to be approached seeking 'no objection' in principle from the security angle for holding of the conference with subject, dates and venue(s) and *other details as above* specified in the letter.

- Political clearance from Ministry of External Affairs: Section Officer (Coordination), Ministry of External Affairs, South Block, New Delhi - 110011 is to be approached seeking political clearance by Ministry of External Affairs for holding of the conference with subject, dates and venue(s) and *other details as above* specified in the letter.

In addition, (as of now) for authorization of visa to participants from (1) Afghanistan, (2) China, (3) Iran, (4) Iraq, (5) Pakistan, (6) Sudan, (7) foreigners of Pakistani Origin and (8) Stateless persons, the information in the format given below, in CD format if number of participants is above 15 (in 3 CDs), is required to be submitted to the Ministry of Home Affairs (Foreigners Division) at least 60 days before the commencement of the said event(s). **It is, however, advisable that the details may be sent to MHA (Foreigners' Division) as soon as the details are available.**

Sl. No.	Name of applicant	Father's / Husband's Name	Nationality	Date of Birth	Place of Birth	Passport Number	Date & Place of Issue	Date of Expiry	Addresses
1	2	3	4	5	6	7	8	9	10

So far as visa authorization to participants from the countries other than those as mentioned above, Indian Missions abroad are authorized to issue conference visas to delegates on production of an invitation letter from the organizer(s) together with copies of MEA's political clearance as well as MHA's security clearance.

In this context it is also worthwhile to look into the new visa scheme of Government of India called e-Tourist Visa that has the requirement that are minimal (refer: <https://indianvisaonline.gov.in/visa/tvoa.html>).

- Clearance from the concerned State Government: Home Ministry of State concerned where Conference is being held is to be approached. Again, it is too more for information to the

authority and they do not usually object, once the clearance from Union Ministries are sent to them.

- Clearance from local law enforcing authority: Commissioner of Police is to be approached from law and order angle. Though it may not be a problem, prior intimation shall be there.

While obtaining the above mentioned statutory clearances *without fail*, in this context for guidance Conference Organizers may like to have a look at the FAQs on Conference Visa at the MHA site (<http://www.mha.nic.in/>) also.

2. Identification of proper IEEE Organizational Unit for association:

- It shall be in consonance with the provisions under IEEE Constitution & Bylaws.

o Usually Geographic Entity concerned within whose area the location of Conference falls, and in case Geographic Council covering not only the area of the concerned Section, but also a cluster of Sections of a country and agrees to provide sponsorship in any form, concerned Section shall also be in the picture.

o in certain cases it may be another Geographic Entity acceptable under Contiguous Section provision of IEEE due to affiliation of large number of IEEE Members from the area of location of Conference to that Geographic Entity. (Similar may be the case with the Student Branch too.)

Conference Financial Reporting:

- While continuously accounting is to be maintained and finally balance sheet is to be prepared, Income Tax Department of Government of India stipulates separate maintenance of accounts and closure thereof with surplus / deficit shown properly along with the names of entities financially involved with the Conference.
- In case of Conferences with IEEE entities having majority stake in financial matter for the Conference and / or having projected income and / or expenditure more than a specified limit, right from the beginning and from time to time till the closure, in prescribed format, reporting has to be done to IEEE.

Additional considerations for International Conferences in India:

- Some basic issues to be considered are
 - Facilities available
 - Connectivity (*physical as well as e-communication*) with the rest of the world
 - Interest of local organizers as well as Institutes and Industries around, *if applicable*
- Considering above, 6 (*six*) Metropolitan cities of the country and in addition, few other cities may be in a position to host International Conferences in India. Of course, extensive availability of e-communication covering other areas vis-à-vis improvement

in transportation, also promise to usher in with feasibility of hosting such International Conference in near future

Submitted by –

Name: Prof S Indu

Conference Position: General Chair

Affiliation: Delhi Technological University, Delhi

Contact Information: HOD, ECE Department, DTU

Email: s.indu@dce.ac.in

Tel / Mo: 9868108678

Address: Professor and Head of the Department
Delhi Technological University, Delhi

Date: 23/05/18